





#### **60V N-CHANNEL ENHANCEMENT MODE MOSFET**

### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub> T <sub>A</sub> = 25°C		
60V	80mΩ @ V <sub>GS</sub> = 10V	7.90A		
60 V	150mΩ @ V <sub>GS</sub> = 4.5V	5.75A		

### **Description and Applications**

This new generation MOSFET has been designed to minimize the onstate resistance ( $R_{DS(on)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- DC-DC Converters
- Power management functions

#### **Features and Benefits**

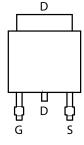
- · Low on-resistance
- Fast switching speed
- "Green" component and RoHS compliant (Note 1)

#### **Mechanical Data**

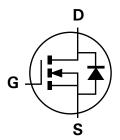
- Case: TO-252
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals Connections: See Diagram
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.33 grams (approximate)



TOP VIEW



PIN OUT -TOP VIEW



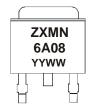
Equivalent Circuit

### Ordering Information (Note 1)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel	
ZXMN6A08KTC	See Below	13	16	2,500	

Note: 1. Diodes, Inc. defines "Green" products as those which are Eu RoHS compliant and contain no halogens or antimony compounds; further information about Diodes Inc.'s "Green" Policy can be found on our website. For packaging details, go to our website.

## **Marking Information**



ZXMN = Product Type Marking Code, Line 1 6A08 = Product Type Marking Code, Line 2 YYWW = Date Code Marking YY = Year (ex: 09 = 2009) WW = Week (01-52)





### **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Cha	racteristic		Symbol Value		Unit	
Drain-Source voltage			$V_{DSS}$	60	V	
Gate-Source voltage			$V_{GS}$	±20	V	
		(Note 3)	I <sub>D</sub>	7.90		
Continuous Drain current	$V_{GS} = 10V$	T <sub>A</sub> =70°C (Note 3)		6.30	Α	
		(Note 2)		5.36		
Pulsed Drain current V <sub>GS</sub> = 10V (No		(Note 4)	$I_{DM}$	24.3	Α	
Continuous Source current (Body diode) (Note 3)			I <sub>S</sub>	9.0	Α	
Pulsed Source current (Body diode) (Note 4)			I <sub>SM</sub>	24.3	А	

### Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit	
	(Note 2)		4.13 33.0		
Power dissipation Linear derating factor	(Note 3)	P <sub>D</sub>	8.94 71.5	W mW/°C	
	(Note 5)		2.12 16.9		
Thermal Resistance, Junction to Ambient	(Note 2) (Note 3) (Note 5)	R <sub>θJA</sub>	30.3 14.0 59.1	°C/W	
Thermal Resistance, Junction to Lead	(Note 6)	$R_{ heta JL}$	2.77		
Operating and storage temperature range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C	

#### Notes:

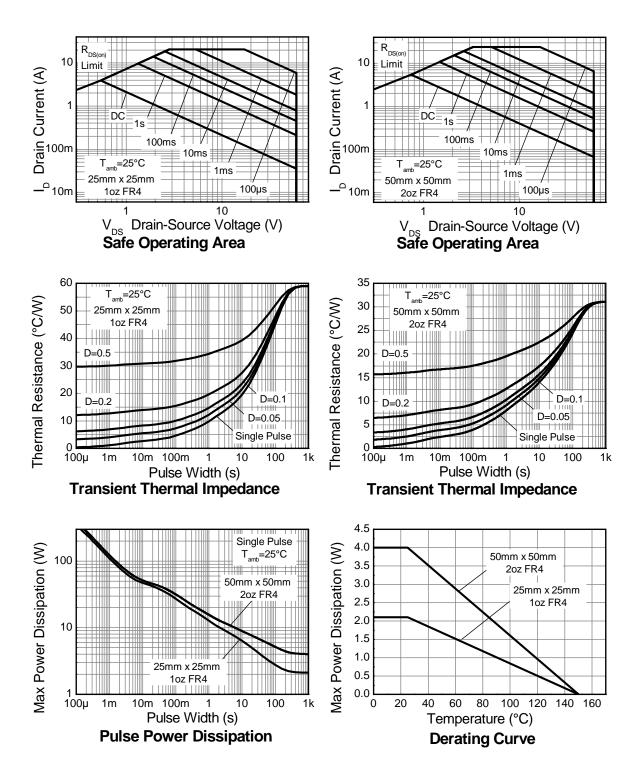
- 2. For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

- Same as note 2, except the device is measured at t ≤ 10 sec.
   Same as note 2, except the device is pulsed with D = 0.02 and pulse width 300 μs. The pulse current is limited by the maximum junction temperature.
   For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- 6. Thermal resistance from junction to solder-point (at the end of the drain lead).





#### Thermal Characteristics







# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Cor	ndition	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	_	_	V	$I_D = 250 \mu A, V_{GS} = 0$	ΟV	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	0.5	μΑ	V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0	V	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V$ , $V_{DS} = 0$	0V	
ON CHARACTERISTICS								
Gate Threshold Voltage	V <sub>GS(th)</sub>	1.0		3.0	٧	$I_D=250\mu A,\ V_{DS}=V_{AB}$	'GS	
Static Drain-Source On-Resistance (Note 7)	В			0.080	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 4.8	Α	
Static Dialif-Source Off-Resistance (Note 1)	R <sub>DS (ON)</sub>	_	_	0.150	12	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 4.2	.A	
Forward Transconductance (Notes 7 & 8)	<b>g</b> fs	_	6.6	_	S	V <sub>DS</sub> = 15V, I <sub>D</sub> = 4.8	4	
Diode Forward Voltage (Note 7)	V <sub>SD</sub>	_	0.88	0.95	V	I <sub>S</sub> = 4.0A, V <sub>GS</sub> = 0V		
Reverse recovery time (Note 8)	t <sub>rr</sub>		19.2	_	ns	I <sub>S</sub> = 1.4A, di/dt= 100A/μs		
Reverse recovery charge (Note 8)	Q <sub>rr</sub>	_	30.3	_	nC	71S= 1.4A, di/di= 10	υΑ/μς	
DYNAMIC CHARACTERISTICS (Note 8)								
Input Capacitance	C <sub>iss</sub>	_	459	_	pF			
Output Capacitance	Coss	_	44.2	_	pF	V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0' f= 1MHz	V	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	24.1	_	pF	1= 11/11/12		
Total Gate Charge	Qg	_	3.8	_	nC	V <sub>GS</sub> = 4.5V		
Total Gate Charge	Qg	_	5.8	_	nC	\	/ <sub>DS</sub> = 30V	
Gate-Source Charge	Q <sub>gs</sub>	_	1.4	_	nC	V <sub>GS</sub> = 10V		
Gate-Drain Charge	$Q_{gd}$	_	1.9	_	nC			
Turn-On Delay Time (Note 9)	t <sub>D(on)</sub>	_	2.6	_	ns			
Turn-On Rise Time (Note 9)	t <sub>r</sub>	_	2.1	_	ns	V <sub>DD</sub> = 30V, V <sub>GS</sub> = 10V		
Turn-Off Delay Time (Note 9)	t <sub>D(off)</sub>	_	12.3	_	ns	$I_D=1.5A, R_G \cong 6.0\Omega$		
Turn-Off Fall Time (Note 9)	t <sub>f</sub>	_	4.6	_	ns			

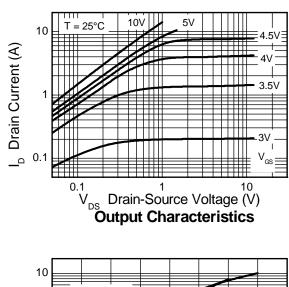
Notes:

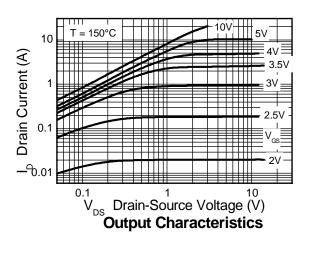
- Measured under pulsed conditions. Pulse width ≤ 300µs; duty cycle ≤ 2%
   For design aid only, not subject to production testing.
   Switching characteristics are independent of operating junction temperatures.

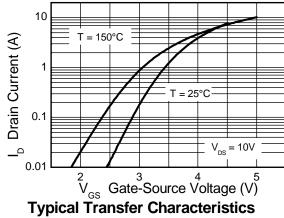


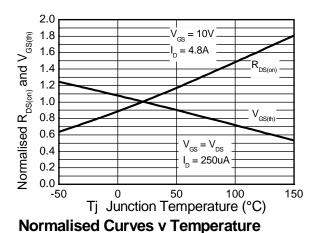


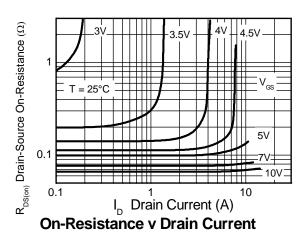
# **Typical Characteristics**

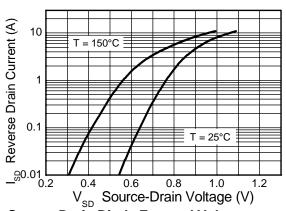








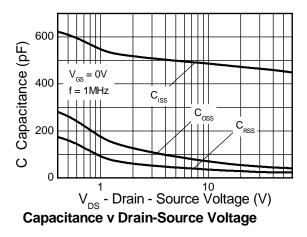


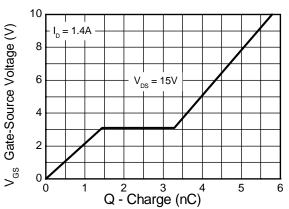


Source-Drain Diode Forward Voltage



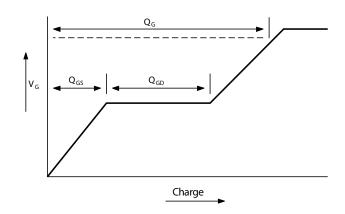
# **Typical Characteristics - continued**





Gate-Source Voltage v Gate Charge

### **Test Circuits**



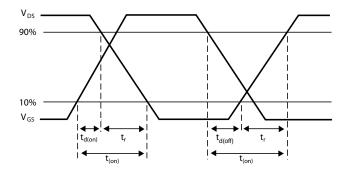
Current regulator

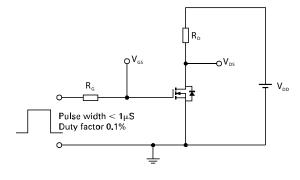
12V 0.2μF 50k D.U.T

V<sub>os</sub>

Basic gate charge waveform

Gate charge test circuit



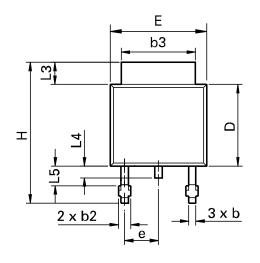


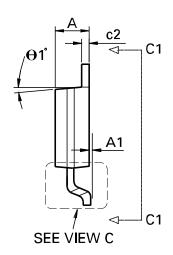
Switching time waveforms

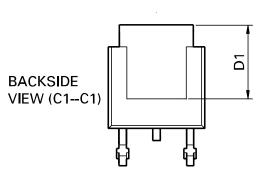
Switching time test circuit

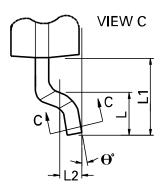


# **Package Outline Dimensions**





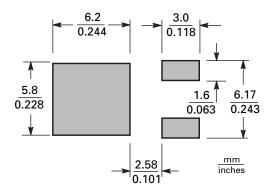




DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min	Max	Min	Max		Min	Max	Min	Max
Α	0.086	0.094	2.18	2.39	е	0.090 BSC		2.29 BSC	
<b>A1</b>	-	0.005	-	0.127	Н	0.370	0.410	9.40	10.41
b	0.020	0.035	0.508	0.89	L	0.055	0.070	1.40	1.78
b2	0.030	0.045	0.762	1.14	L1	0.108 REF		2.74 REF	
b3	0.205	0.215	5.21	5.46	L2	0.020 BSC		0.508 BSC	
С	0.018	0.024	0.457	0.61	L3	0.035	0.065	0.89	1.65
c2	0.018	0.023	0.457	0.584	L4	0.025	0.040	0.635	1.016
D	0.213	0.245	5.41	6.22	L5	0.045	0.060	1.14	1.52
D1	0.205	-	5.21	-	θ1°	0°	10°	0°	10°
E	0.250	0.265	6.35	6.73	θ°	0°	15°	0°	15°
E1	0.170	-	4.32	-	-	-	-	-	-



### **Suggested Pad Layout**



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